



PRODUCT DATASHEET



- PLCC2 SMD
- 2835 <u>1W Series</u>
 - Red (625nm)

Release Date: 26 November 2014 Version: A1.0



RóHS Compliant





- Package: PLCC2 High Power White SMT Package
- Forward Current: 350mA
- Forward Voltage (typ.): 2.4V
- Luminous Flux (typ.): 36lm @350mA
- Colour: Red
- Wavelength: 625nm
- Viewing angle: 120°
- Materials:
 - Die: AlGaInP
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
 - Forward voltage
 - Luminous flux
 - Dominant wavelength
- Soldering methods: IR Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 12mm tape with 2000/reel, ø180mm (7")



NOR15S52

APPLICATIONS:

- Decorative Lighting
- Backlighting
- Indicator
- Display





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	350	mA
Peak Forward Current (Duty 1/10; width 10KHz)	I _{FP}	700	mA
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	1050	mW
Electrostatic Discharge	ESD	2000	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	T _{SD}	260	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Onit	Condition
Forward Voltage	V _F	1.8	2.4	3.0	V	I _F =350mA
Luminous Flux	Φν	33	36	45	lm	I _F =350mA
Dominant Wavelength	λ_{D}	620	625	630	nm	I _F =350mA
Spectral Half Width	Δλ		20		nm	I _F =350mA
Viewing Angle	20 _{1/2}		120		deg	I _F =350mA

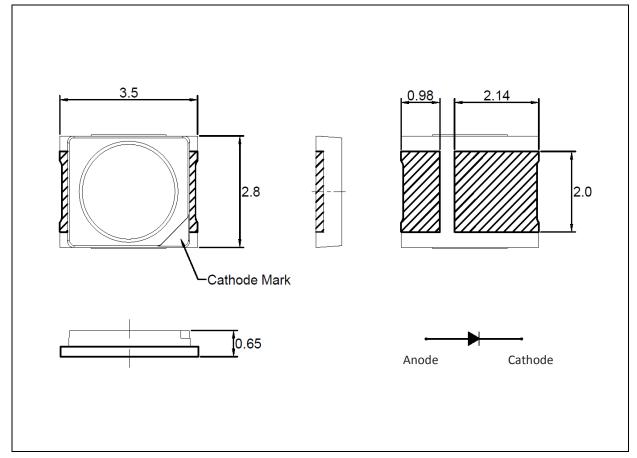
1. Luminous intensity (I_v) ±15%, Forward Voltage (V_F) ±0.1V, Viewing angle(2 $\theta_{1/2}$) ±5%

2. IS standard testing



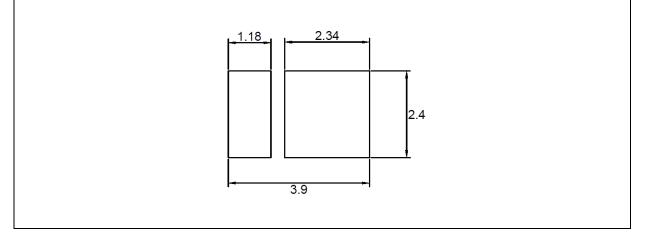
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code	Min.	Max.	Unit
С	1.8	1.9	
D	1.9	2.0	
E	2.0	2.1	
F	2.1	2.2	
G	2.2	2.3	
н	2.3	2.4	v
I	2.4	2.5	v
J	2.5	2.6	
к	2.6	2.7	
L	2.7	2.8	
М	2.8	2.9	
N	2.9	3.0	

Forward Voltage Classifications ($I_F = 350 \text{mA}$):

Luminous Flux Classifications (I_F = 350mA):

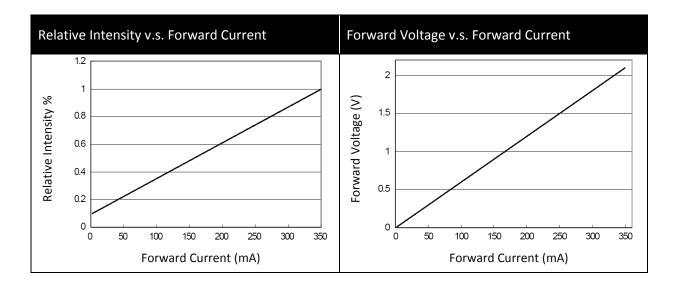
Code	Min.	Max.	Unit
F33T	33	36	
F36T	36	39	Im
F39T	39	42	lm
F42T	42	45	

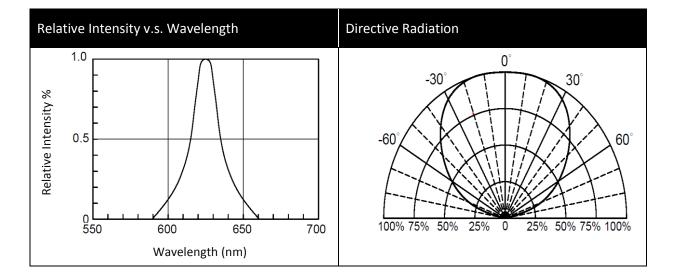
Dominant Wavelength Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
D	620	625	2.22
E	625	630	nm



ELECTRO-OPTICAL CHARACTERISTICS:

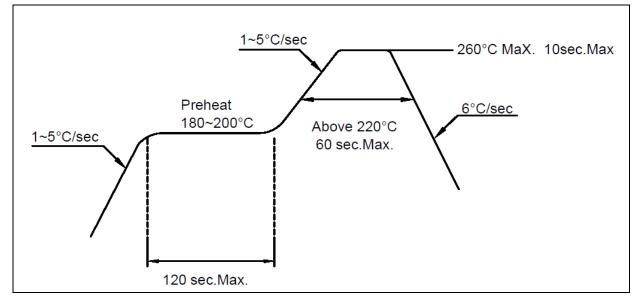






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



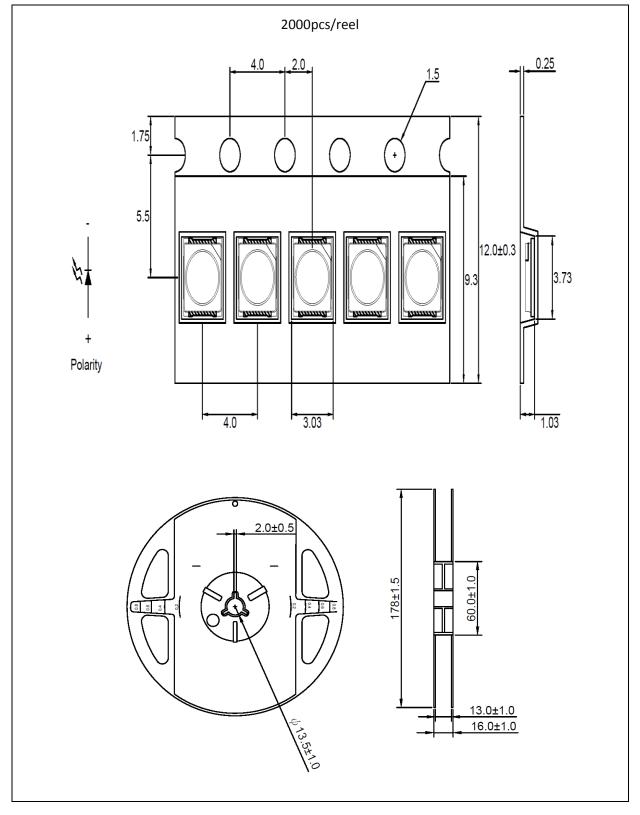
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	26/11/2014	Datasheet set-up.